

TO-220AB Plastic-Encapsulate MOSFETS

IRF540 N-Channel Power MOSFET

GENERAL DESCRIPTION

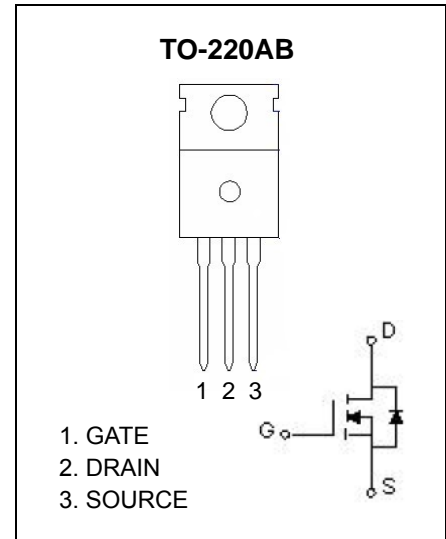
It uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge .This device is suitable for high current load applications.

FEATURE

- High current rating
- Ultra lower $R_{DS(on)}$
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

APPLICATION

- Power switching application
- Load switching in high circuit application
- DC/DC converters



Maximum ratings ($T_a=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current	I_D	27	A
Pulsed Drain Current	I_{DM}	50	
Single Pulsed Avalanche Energy (note1)	E_{AS}	250	mJ
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	62.5	$^{\circ}\text{C}/\text{W}$
Junction Temperature	T_J	150	$^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	-55 ~+150	
Maximum lead temperature for soldering purposes , 1/8"from case for 5 seconds	T_L	260	

Electrical characteristics (T_a=25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Off characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D =250μA	200			V
Zero gate voltage drain current	I _{DSS}	V _{DS} =100V, V _{GS} =0V			25	μA
Gate-body leakage current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
On characteristics (note2)						
Gate-threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	2		4	V
Static drain-source on-resistance	R _{DS(on)}	V _{GS} =10V, I _D =7.5A			80	mΩ
Forward transconductance	g _{fs}	V _{DS} =50V, I _D =7.5A	3.8			S
Dynamic characteristics (note 3)						
Input capacitance	C _{iss}	V _{DS} =25V, V _{GS} =0V, f =1MHz		800		pF
Output capacitance	C _{oss}			240		
Reverse transfer capacitance	C _{rss}			76		
Switching characteristics (note 3)						
Turn-on delay time	t _{d(on)}	V _{DD} =100V, V _{GS} =10V, R _G =12Ω, I _D =5.9A		9.4		ns
Turn-on rise time	t _r			28		
Turn-off delay time	t _{d(off)}			39		
Turn-off fall time	t _f			20		
Drain-Source Diode Characteristics						
Drain-source diode forward voltage(note2)	V _{SD}	V _{GS} = 0V, I _S =14A			2	V
Continuous drain-source diode forward current(note4)	I _S				9.3	A
Pulsed drain-source diode forward current	I _{SM}				37	A

Notes :

1. L=4.6mH, I_L=9.9A, V_{DD}=50V, R_G=25Ω, Starting T_J=25°C.
2. Pulse Test : Pulse width≤300μs, duty cycle ≤2%.
3. Guaranteed by design, not subject to production
4. Surface mounted on FR4 board, t≤10s